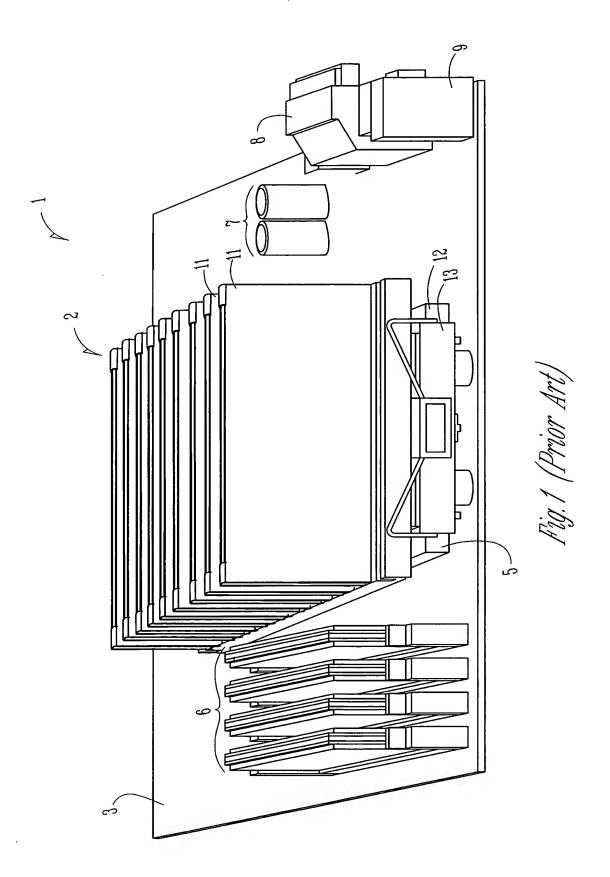
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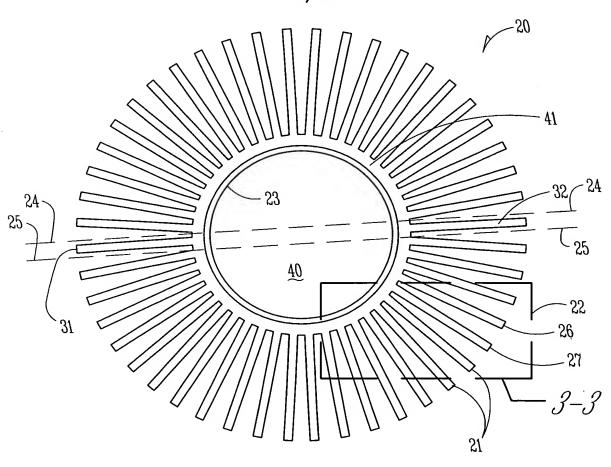


Fig.2 (Prior Art)

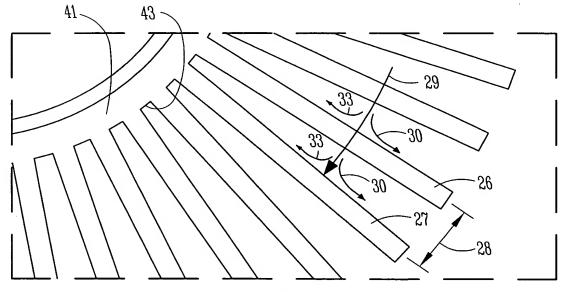
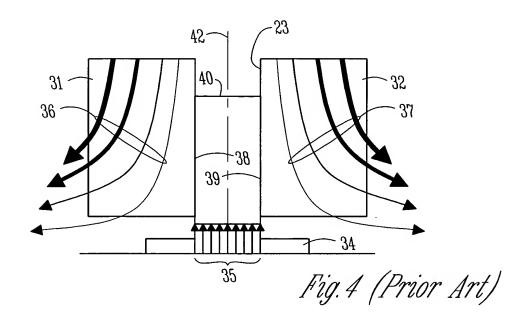
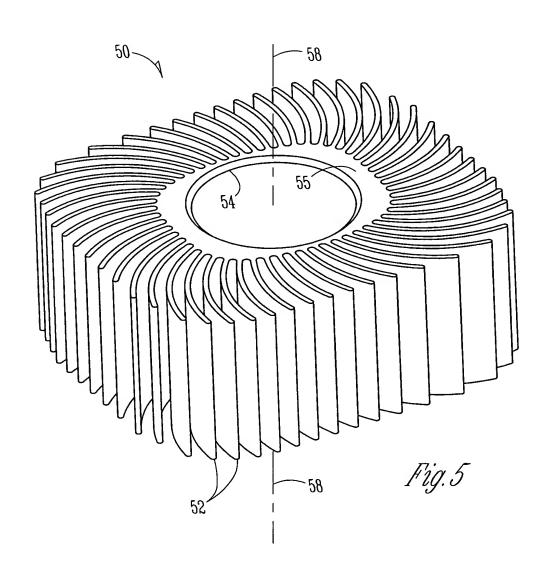


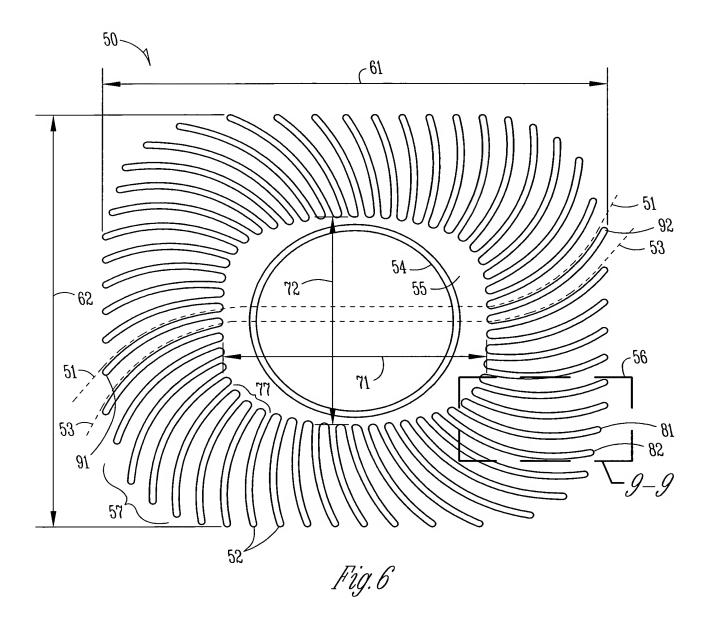
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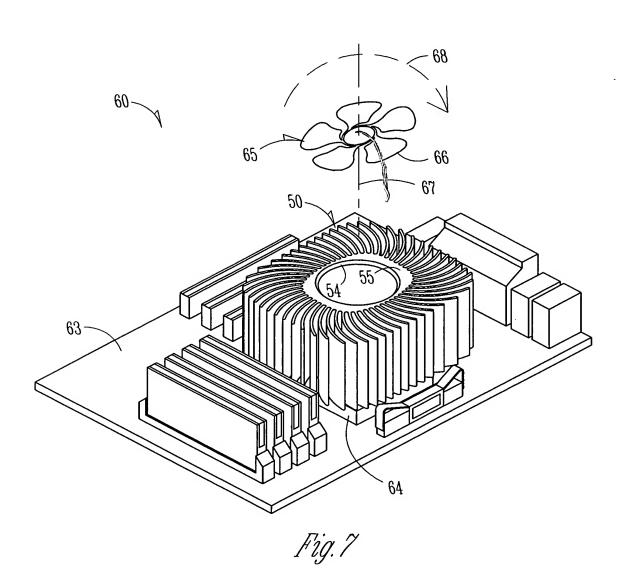
TITLE: ELECTRONIC ASSEMBLIES WITH HIGH CAPACITY HEAT SINKS INVENTORS NAME: Daniel P. Carter et al.

3/18

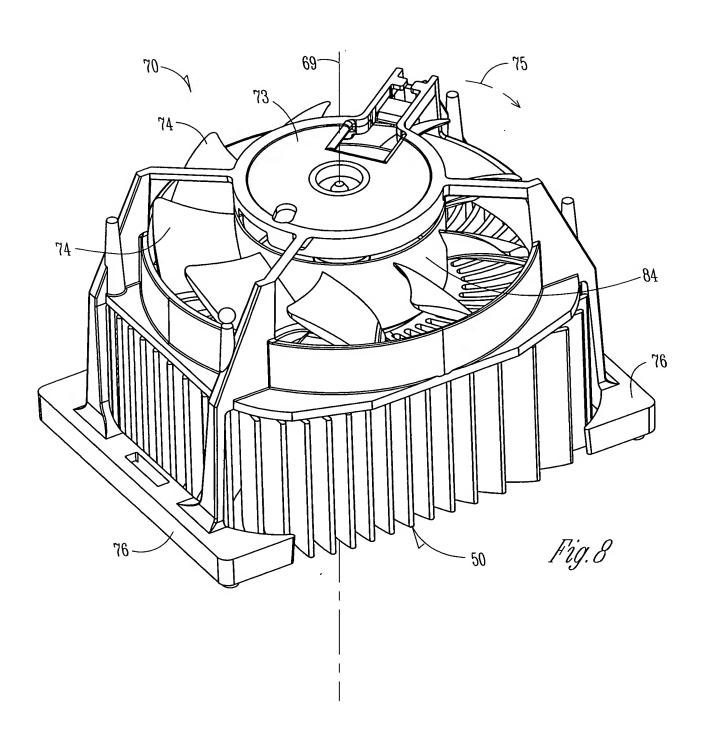








Dkt #: 884.467US3



7/18

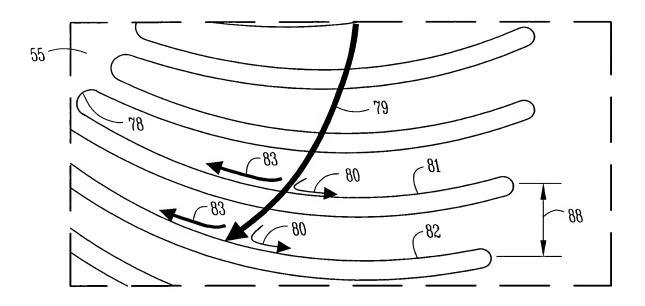
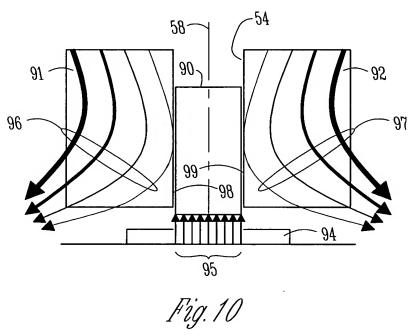
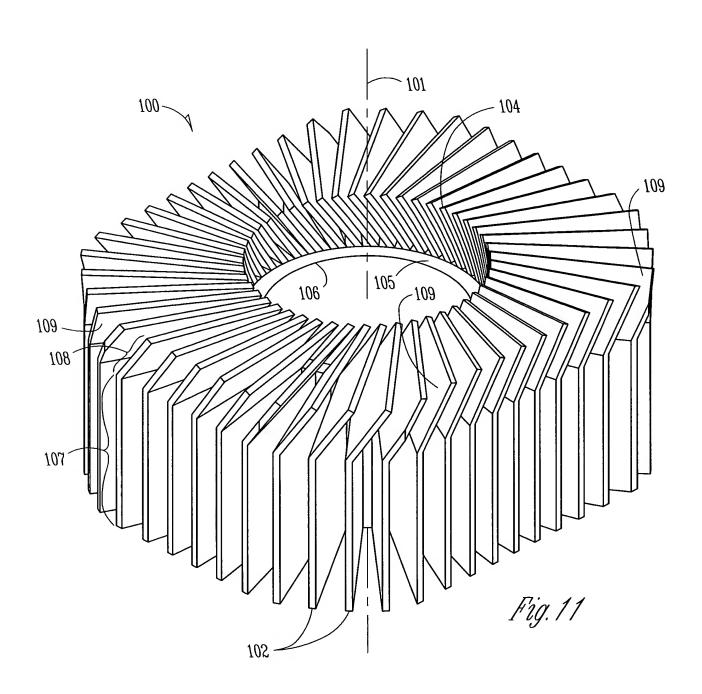
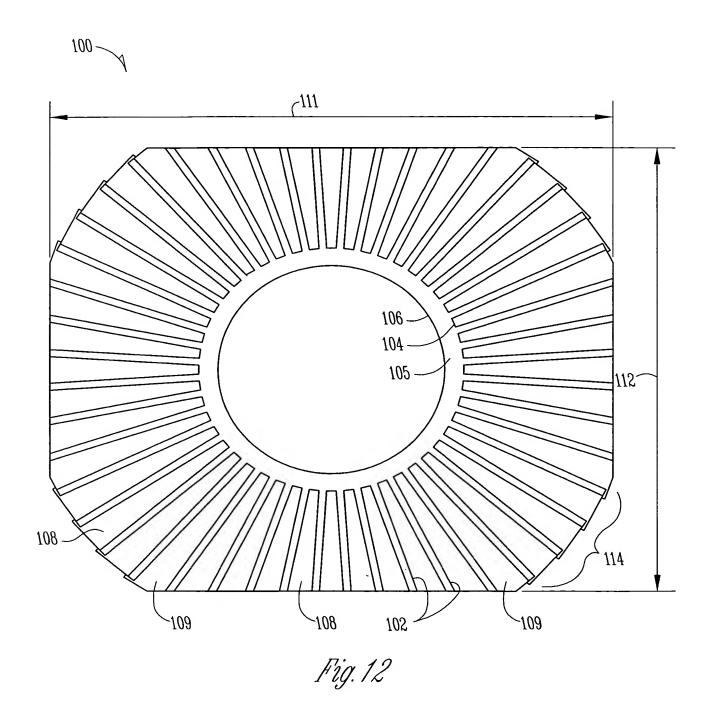


Fig. 9





Dkt #: 884.467US3



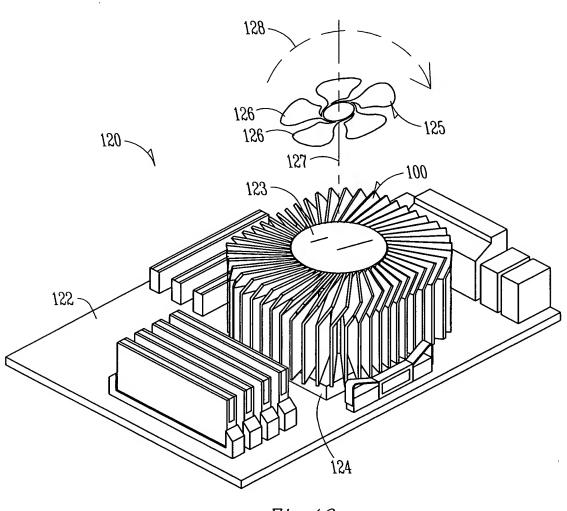
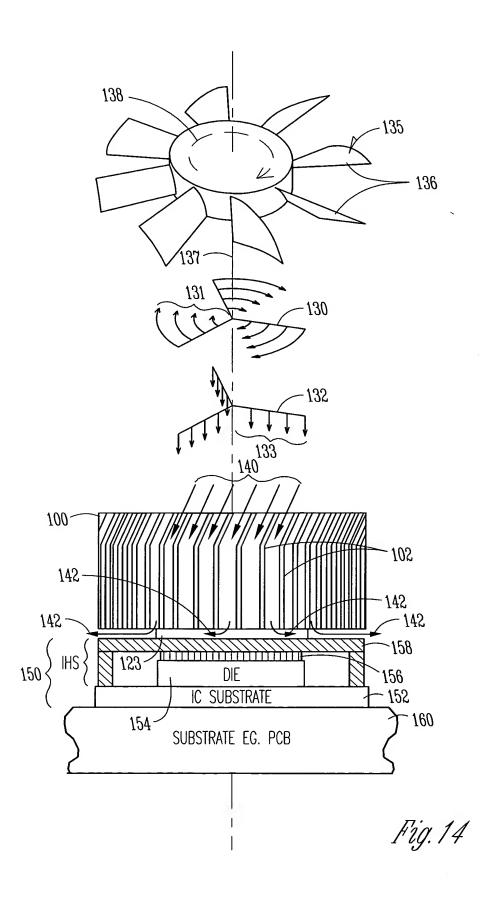


Fig. 13

11/18



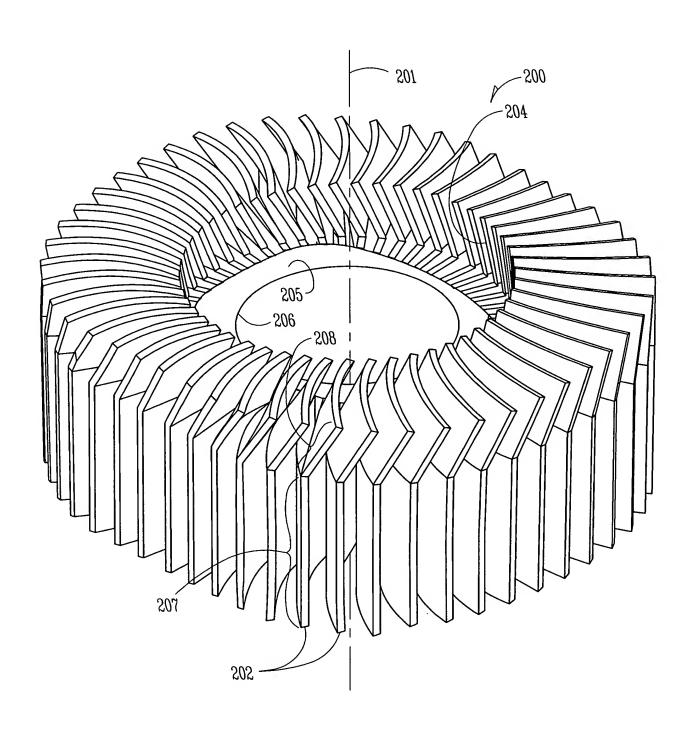
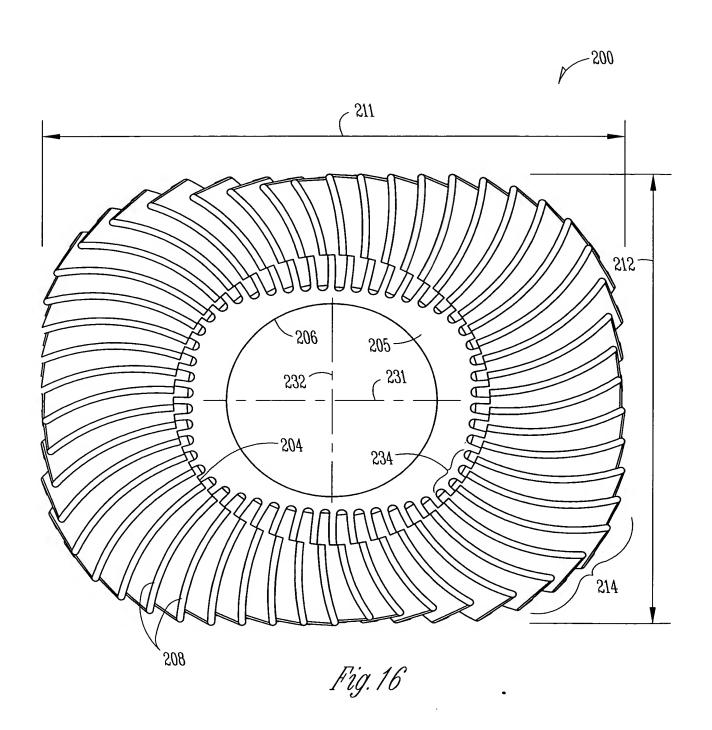
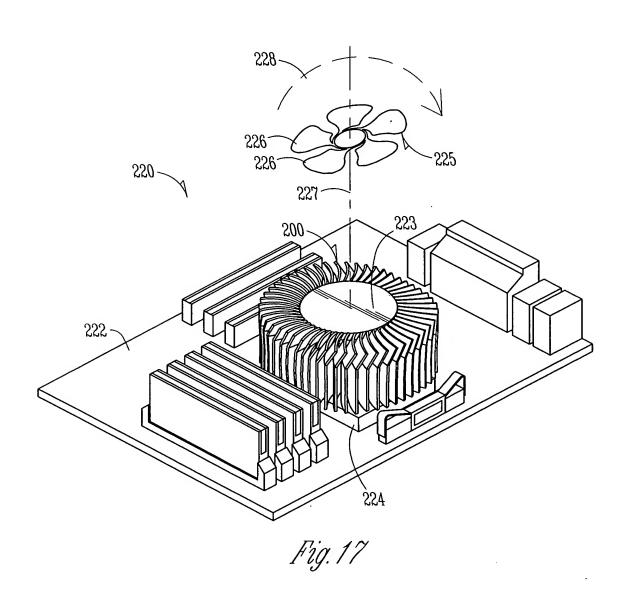


Fig. 15

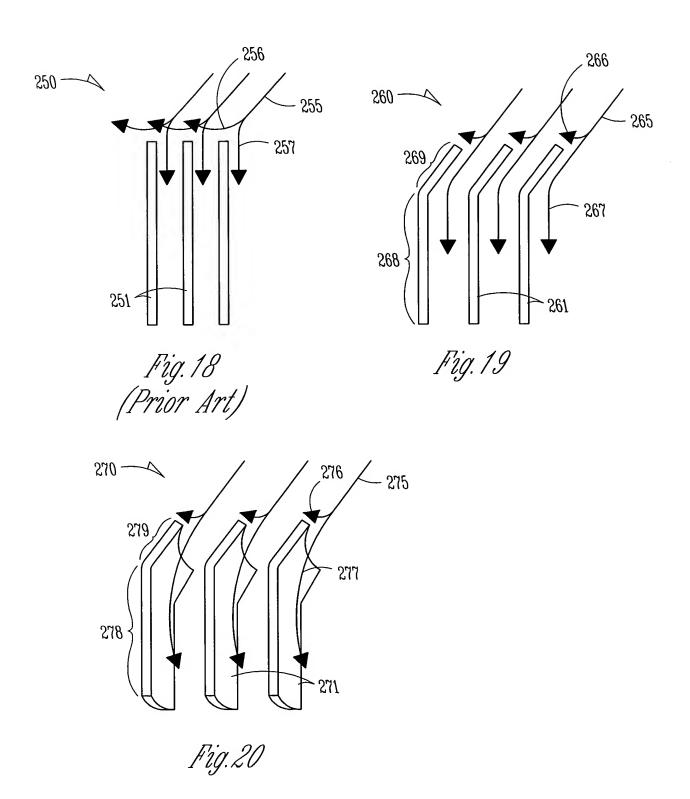
13/18





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INVENTORS NAME: Daniel P. Carter et al. Dkt #: 884.467US3



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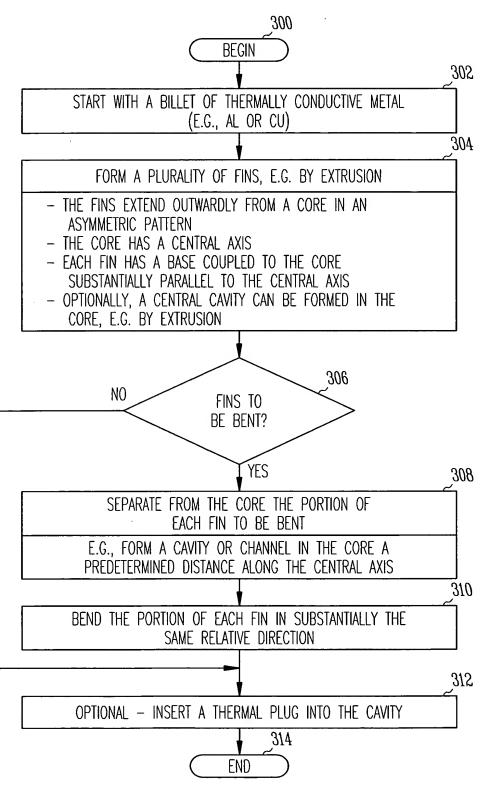


Fig.21

Dkt #: 884.467US3

17/18

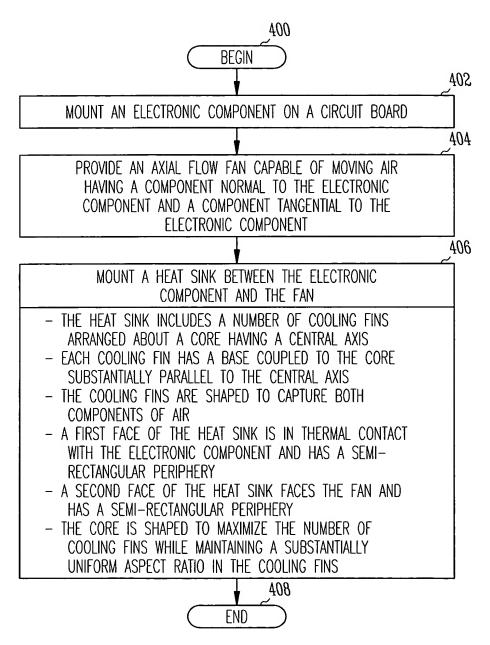


Fig.22

18/18

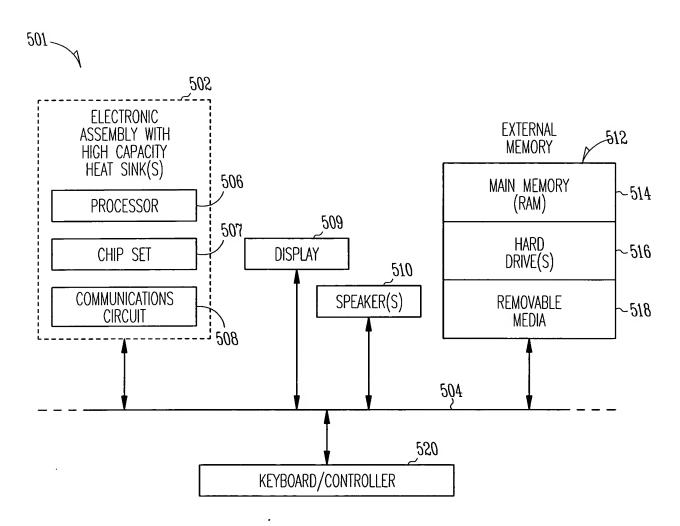


Fig.23